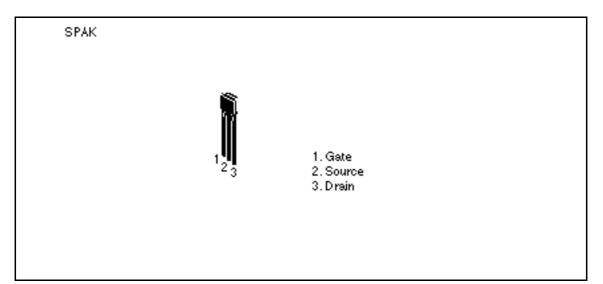
Silicon N-Channel MOS FET

# HITACHI

#### Application

VHF amplifier

#### Outline





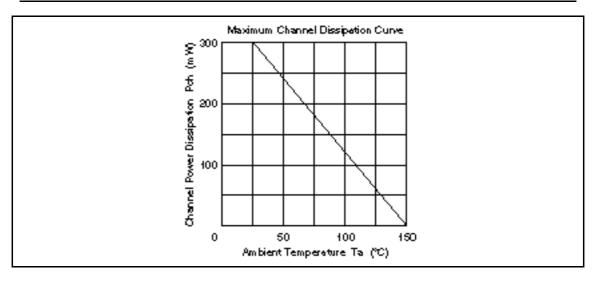
#### **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DS</sub>	20	V
Gate to source voltage	V <sub>GSS</sub>	±5	V
Drain current	I <sub>D</sub>	30	mA
Gate current	l <sub>G</sub>	±1	mA
Channel power dissipation	Pch	300	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

### **Electrical Characteristics** (Ta = $25^{\circ}$ C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSX}}$	20	_	_	V	$I_{\rm D} = 100 \ \mu A, \ V_{\rm GS} = -4 \ V$	
Gate cutoff current	I <sub>GSS</sub>	—	—	±20	nA	$V_{GS} = \pm 5 V, V_{DS} = 0$	
Drain current	I*1	4	—	12	mA	$V_{DS} = 10 V, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	0	_	-2.0	V	$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 10 \mu\text{A}$	
Forward transfer admittance	y <sub>fs</sub>	8	14	—	mS	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ kHz}$	
Input capacitance	Ciss	_	2.5	_	pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1$ MHz	
Reverse transfer capacitance	Crss	_	0.03	—	pF	-	
Output capacitance	Coss	—	1.8	—	pF	$V_{DS} = 5 V, V_{GS} = 0, f = 1 MHz$	
Power gain	PG	_	30	_	dB	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$ f = 100 MHz	
Noise figure	NF	—	2.0	_	dB	-	
Note: 1. The 2SK439 is grouped by I <sub>DSS</sub> as follows.							
Grade D E		F					
I <sub>DSS</sub> 4 to 8 6 t	:o 10	8 to 12					

See characteristic curves of 2SK359.



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